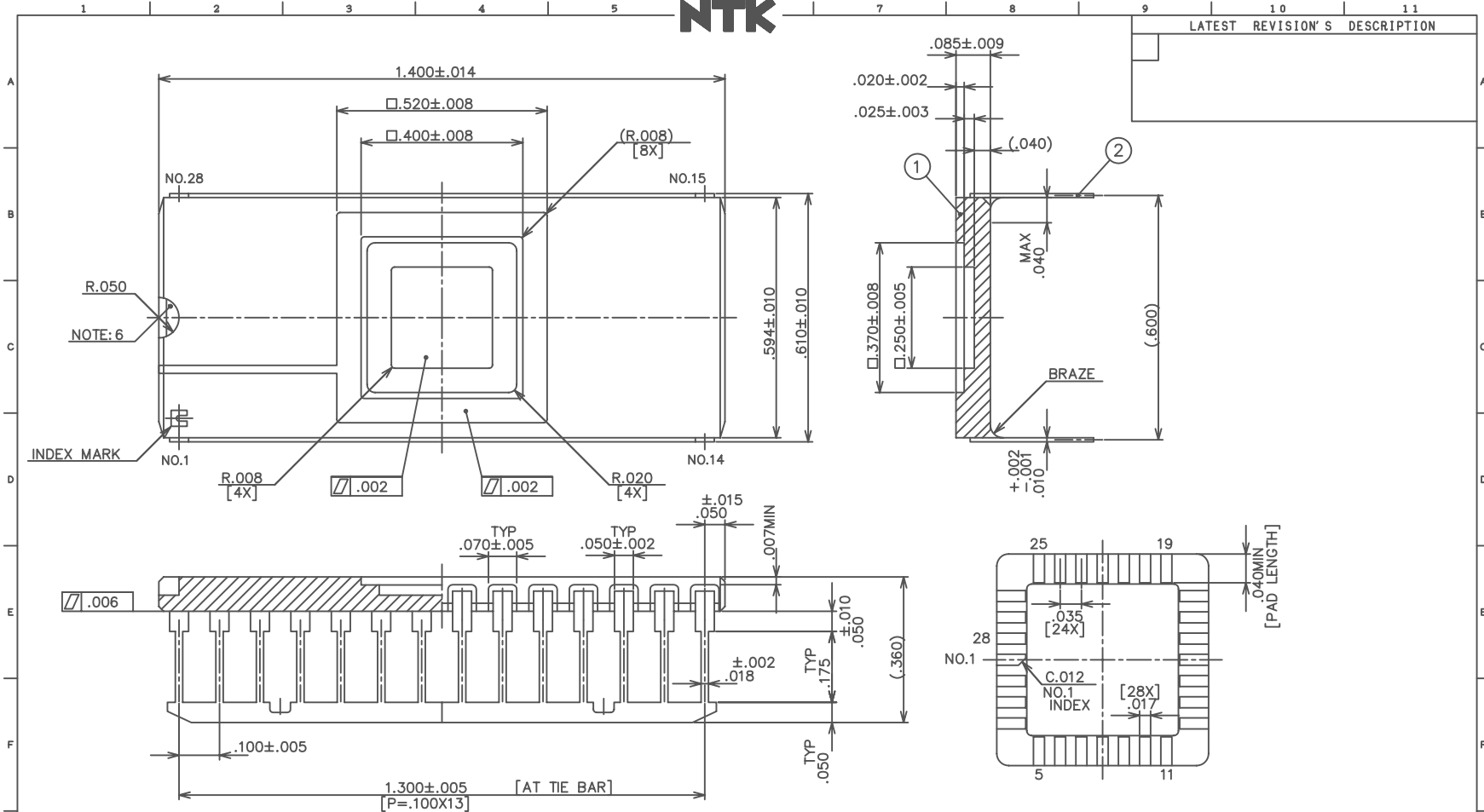


SSM P/N CSB02801

NTK

LATEST REVISION'S DESCRIPTION



- NOTES;
1. GOLD PLATE 60? INCHES MIN OVER 80? INCHES MIN NICKEL.
 2. PLATING TIE BAR TO BE BROKEN AFTER PACKAGE PLATING AT CERAMIC END.
 3. NO LEAD ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD. SEAL RING ISOLATED.
 4. LEAD RESISTANCE : 350m? MAX
 5. NTK SPECIFICATION YS-1002 SHALL APPLY.
 6. THIS METALLIZATION TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD.

B/G PADS DETAIL

Item	Name	Material	Description	Rev.	Description	Date
3						
2	LEAD	ALLOY42		B	RE DRAWING	MAY-06-1991
1	CERAMIC	BLACK ALUMINA		A	RE DRAWING	NOV-21-1983
UNLESS OTHERWISE SPECIFIED TOLERANCES: ± 1 %			DRAWN	NTK		
N. L. T. 2 DECIMALS . XX ±0.25			CHECKED	NGK SPARK PLUG CO., LTD.		
CUSTOMER			APPROVED	TITLE		
SPECTRUM			T.NOMURA	28 LEAD S/B PKG		
DWG NO.			UNIT MM	DWG NO.		
			SCALE	IDK28F1-247EAL		

MODIFIED DWG NO.

PART NO. SHEET 1 OF 1



